

# ISL54212

## MP3/USB 2.0 High Speed Switch with Negative Signal Handling

FN6556

Rev 0.00

September 18, 2007

The Intersil ISL54212 dual SPDT (Single Pole/Double Throw) switches combine low distortion audio and accurate USB 2.0 high speed data (480Mbps) signal switching in the same low voltage device. When operated with a 2.5V to 5.5V single supply these analog switches allow audio signal swings below-ground, allowing the use of a common USB and audio headphone connector in Personal Media Players and other portable battery powered devices.

The ISL54212 logic control pins are 1.8V compatible which allows for control via a standard  $\mu$ controller. The part has an audio enable control pin to open all the switches and put the part in a low power state.

The ISL54212 is available in a small 10 Ld 2.1mmx1.6mm ultra-thin  $\mu$ TQFN package and a 10 Ld 3mmx3mm TDFN package. It operates over a temperature range of -40 to +85°C.

### Related Literature

- Technical Brief TB363 "Guidelines for Handling and Processing Moisture Sensitive Surface Mount Devices (SMDs)"
- Application Note AN557 "Recommended Test Procedures for Analog Switches"

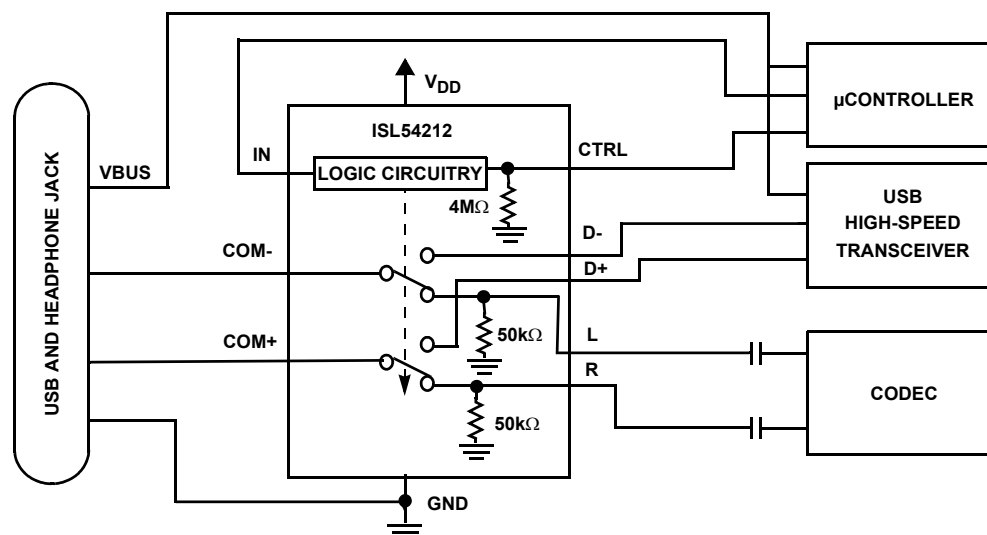
### Features

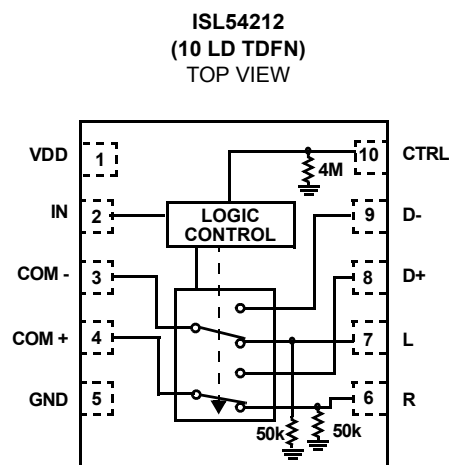
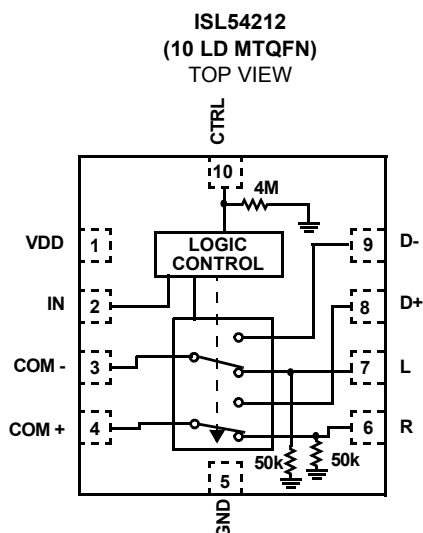
- High Speed (480Mbps) and Full Speed (12Mbps) Signaling Capability per USB 2.0
- Low Distortion Negative Signal Capability
- Control Pin to Open all Switches and Enter Low Power State
- Low Distortion Headphone Audio Signals
  - THD+N at 15mW into 32 $\Omega$  Load . . . . . <0.06%
- Cross-talk Audio Channels (20Hz to 20kHz) . . . . . -110dB
- Single Supply Operation ( $V_{DD}$ ) . . . . . 2.5V to 5.5V
- -3dB Bandwidth USB Switches . . . . . 630MHz
- Available in  $\mu$ TQFN and TDFN Packages
- Pb-Free (RoHS Compliant)
- Compliant with USB 2.0 Short Circuit Requirements Without Additional External Components

### Applications

- MP3 and Other Personal Media Players
- Cellular/Mobile Phones
- PDA's
- Audio/USB Switching

### Application Block Diagram



**Pinouts** (Note 1)

NOTE:

1. ISL54212 Switches shown for IN = Logic "1" and CTRL = Logic "1".

**Truth Table**

ISL54212			
IN	CTRL	L, R	D+, D-
0	X	OFF	ON
1	0	OFF	OFF
1	1	ON	OFF

IN: Logic "0" when  $\leq 0.5V$ , Logic "1" when  $\geq 1.4V$  with 2.7V to 3.6V supply.

CTRL: Logic "0" when  $\leq 0.5V$  or Floating, Logic "1" when  $\geq 1.4V$  with 2.7V to 3.6V supply.

**Pin Descriptions**

ISL54212		
PIN NO.	NAME	FUNCTION
1	VDD	Power Supply
2	IN	Digital Control Input
3	COM-	Voice and Data Common Pin
4	COM+	Voice and Data Common Pin
5	GND	Ground Connection
6	R	Audio Right Input
7	L	Audio Left Input
8	D+	USB Differential Input
9	D-	USB Differential Input
10	CTRL	Digital Control Input (Audio Enable)

**Ordering Information**

PART NUMBER (Note)	PART MARKING	TEMP. RANGE (°C)	PACKAGE (Pb-Free)	PKG. DWG. #
ISL54212IRTZ	12Z	-40 to +85	10 Ld 3mmx3mm TDFN	L10.3x3A
ISL54212IRTZ-T*	12Z	-40 to +85	10 Ld 3mmx3mm TDFN Tape and Reel	L10.3x3A
ISL54212IRUZ-T*	FX	-40 to +85	10 Ld $\mu$ TQFN	L10.2.1X1.6A

\*Please refer to TB347 for details on reel specifications.

NOTE: These Intersil Pb-free plastic packaged products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate PLUS ANNEAL - e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

**Absolute Maximum Ratings**

VDD to GND	-0.3V to 6.0V
Input Voltages	
D+, D-, L, R (Note 2)	-2V to ((VDD) + 0.3V)
IN (Note 2)	-2V to 5.5V
CTRL (Note 2)	-0.3 to ((VDD) + 0.3V)
Output Voltages	
COM-, COM+ (Note 2)	-2V to ((VDD) + 0.3V)
Continuous Current (Audio Switches)	±150mA
Peak Current (Audio Switches)	
(Pulsed 1ms, 10% Duty Cycle, Max)	±300mA
Continuous Current (USB Switches)	±40mA
Peak Current (USB Switches)	
(Pulsed 1ms, 10% Duty Cycle, Max)	±100mA
ESD Rating:	
HBM	>7kV
MM	>400V
CDM	>1.4kV

**CAUTION:** Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

**NOTES:**

- Signals on D+, D-, L, R, COM-, COM+, CTRL, IN exceeding VDD or GND by specified amount are clamped. Limit current to maximum current ratings.
- $\theta_{JA}$  is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

**Electrical Specifications - 2.7V to 3.6V Supply** Test Conditions: VDD = +3.3V, GND = 0V, VINH = 1.4V, VINL = 0.5V, VCTRLH = 1.4V, VCTRL = 0.5V, (Note 4), unless otherwise specified.

PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN (Notes 5, 8)	TYP	MAX (Notes 5, 8)	UNITS
<b>ANALOG SWITCH CHARACTERISTICS</b>						
<b>Audio Switches (L, R)</b>						
Analog Signal Range, VANALOG	VDD = 3.0V, IN = 1.4V, CTRL = 1.4V	Full	-1.5	-	1.5	V
ON Resistance, RON	VDD = 5.0V, IN = CTRL = VDD, ICOMx = 40mA, VL or VR = -0.85V to 0.85V, (See Figure 3)	25	-	2.47	-	Ω
ON Resistance, RON	VDD = 4.2V, IN = CTRL = VDD, ICOMx = 40mA, VL or VR = -0.85V to 0.85V, (See Figure 3)	25	-	2.50	-	Ω
ON Resistance, RON	VDD = 2.85V, IN = CTRL = VDD, ICOMx = 40mA, VL or VR = -0.85V to 0.85V, (See Figure 3)	25	-	2.87	-	Ω
ON Resistance, RON	VDD = 3.0V, IN = 1.4V, CTRL = 1.4V, ICOMx = 40mA, VL or VR = -0.85V to 0.85V, (See Figure 3)	25	-	2.65	4.0	Ω
		Full	-	-	5.5	Ω
RON Matching Between Channels, ΔRON	VDD = 3.0V, IN = 1.4V, CTRL = 1.4V, ICOMx = 40mA, VL or VR = Voltage at max RON over signal range of -0.85V to 0.85V, (Note 7)	25	-	0.02	0.33	Ω
		Full	-	-	0.39	Ω
RON Flatness, RFLAT(ON)	VDD = 3.0V, IN = 1.4V, CTRL = 1.4V, ICOMx = 40mA, VL or VR = -0.85V to 0.85V, (Note 6)	25	-	0.04	0.07	Ω
		Full	-	-	0.09	Ω
Discharge Pull-Down Resistance, RL, RR	VDD = 3.6V, IN = CTRL = 3.6V, VCOM- or VCOM+ = -0.85V, 0.85V, VL or VR = -0.85V, 0.85V, VD+ and VD- = floating, Measure current through the discharge pull-down resistor and calculate resistance value.	25	-	50	-	kΩ
<b>USB Switches (D+, D-)</b>						
Analog Signal Range, VANALOG	VDD = 3.6V, IN = 0.5V, CTRL = 1.4V	Full	0	-	VDD	V
ON Resistance, RON	VDD = 5.0V, IN = 0V, CTRL = VDD, ICOMx = 1mA, VD+ or VD- = 5V (See Figure 4)	+25	-	17.7	-	Ω
ON Resistance, RON	VDD = 4.2V, IN = 0V, CTRL = VDD, ICOMx = 1mA, VD+ or VD- = 4.2V (See Figure 4)	+25	-	19.5	-	Ω

**Thermal Information**

Thermal Resistance (Typical, Note 3)	$\theta_{JA}$ (°C/W)
10 Ld $\mu$ TQFN Package	130
10 Ld 3x3 TDFN Package	110
Maximum Junction Temperature (Plastic Package)	+150°C
Maximum Storage Temperature Range	-65°C to +150°C
Pb-free reflow profile.	see link below
<a href="http://www.intersil.com/pbfree/Pb-FreeReflow.asp">http://www.intersil.com/pbfree/Pb-FreeReflow.asp</a>	

**Operating Conditions**

Temperature Range	-40°C to +85°C
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**Electrical Specifications - 2.7V to 3.6V Supply** Test Conditions:  $V_{DD} = +3.3V$ ,  $GND = 0V$ ,  $V_{INH} = 1.4V$ ,  $V_{INL} = 0.5V$ ,  $V_{CTRLH} = 1.4V$ ,  $V_{CTRL} = 0.5V$ , (Note 4), unless otherwise specified. (Continued)

PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN (Notes 5, 8)	TYP	MAX (Notes 5, 8)	UNITS
ON Resistance, R <sub>ON</sub>	V <sub>DD</sub> = 2.85V, I <sub>N</sub> = 0V, CTRL = V <sub>DD</sub> , I <sub>COMx</sub> = 1mA, V <sub>D+</sub> or V <sub>D-</sub> = 2.85V (See Figure 4)	+25	-	26	-	Ω
ON Resistance, R <sub>ON</sub>	V <sub>DD</sub> = 3.3V, I <sub>N</sub> = 0.5V, CTRL = 1.4V, I <sub>COMx</sub> = 1mA, V <sub>D+</sub> or V <sub>D-</sub> = 3.3V (See Figure 4)	+25	-	23.5	38	Ω
		Full	-	-	43	Ω
ON Resistance, R <sub>ON</sub>	V <sub>DD</sub> = 3.6V, I <sub>N</sub> = 0.5V, CTRL = 1.4V, I <sub>COMx</sub> = 40mA, V <sub>D+</sub> or V <sub>D-</sub> = 0V to 400mV (See Figure 4)	25	-	4.6	5	Ω
		Full	-	-	6.5	Ω
R <sub>ON</sub> Matching Between Channels, ΔR <sub>ON</sub>	V <sub>DD</sub> = 3.6V, I <sub>N</sub> = 0.5V, CTRL = 1.4V, I <sub>COMx</sub> = 40mA, V <sub>D+</sub> or V <sub>D-</sub> = Voltage at max R <sub>ON</sub> over signal range of 0V to 400mV, (Note 7)	25	-	0.06	0.5	Ω
		Full	-	-	0.55	Ω
R <sub>ON</sub> Flatness, R <sub>FLAT</sub> (ON)	V <sub>DD</sub> = 3.6V, I <sub>N</sub> = 0.5V, CTRL = 1.4V, I <sub>COMx</sub> = 40mA, V <sub>D+</sub> or V <sub>D-</sub> = 0V to 400mV, (Note 6)	25	-	0.4	0.6	Ω
		Full	-	-	1.0	Ω
OFF Leakage Current, I <sub>D+(OFF)</sub> or I <sub>D-(OFF)</sub>	V <sub>DD</sub> = 3.6V, I <sub>N</sub> = CTRL = 3.6V, V <sub>COM-</sub> or V <sub>COM+</sub> = 0.5V, 0V, V <sub>D+</sub> or V <sub>D-</sub> = 0V, 0.5V, V <sub>L</sub> and V <sub>R</sub> = float	25	-10	-	10	nA
		Full	-70	-	70	nA
ON Leakage Current, I <sub>Dx</sub>	V <sub>DD</sub> = 3.3V, I <sub>N</sub> = 0.5V, CTRL = 0V or 3.3V, V <sub>D+</sub> or V <sub>D-</sub> = 2.0V, V <sub>COM-</sub> , V <sub>COM+</sub> , V <sub>L</sub> and V <sub>R</sub> = float	25	-10	2	10	nA
		Full	-75	-	75	nA
DYNAMIC CHARACTERISTICS						
Turn-ON Time, t <sub>ON</sub>	V <sub>DD</sub> = 2.7V, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 10pF, (See Figure 1)	25	-	67	-	ns
Turn-OFF Time, t <sub>OFF</sub>	V <sub>DD</sub> = 2.7V, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 10pF, (See Figure 1)	25	-	48	-	ns
Break-Before-Make Time Delay, t <sub>D</sub>	V <sub>DD</sub> = 2.7V, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 10pF, (See Figure 2)	25	-	18	-	ns
Skew, t <sub>SKEW</sub>	V <sub>DD</sub> = 3.3V, I <sub>N</sub> = 0V, CTRL = 3.3V, R <sub>L</sub> = 45Ω, C <sub>L</sub> = 10pF, t <sub>R</sub> = t <sub>F</sub> = 750ps at 480Mbps, (Duty Cycle = 50%) (See Figure 7)	25	-	50	-	ps
Total Jitter, t <sub>J</sub>	V <sub>DD</sub> = 3.3V, I <sub>N</sub> = 0V, CTRL = 3.3V, R <sub>L</sub> = 45Ω, C <sub>L</sub> = 10pF, t <sub>R</sub> = t <sub>F</sub> = 750ps at 480Mbps	25	-	210	-	ps
Propagation Delay, t <sub>pD</sub>	V <sub>DD</sub> = 3.3V, I <sub>N</sub> = 0V, CTRL = 3.3V, R <sub>L</sub> = 45Ω, C <sub>L</sub> = 10pF, (See Figure 7)	25	-	250	-	ps
Crosstalk (Channel-to-Channel), R to COM-, L to COM+	V <sub>DD</sub> = 3.3V, I <sub>N</sub> = CTRL = 3.3V, R <sub>L</sub> = 32Ω, f = 20Hz to 20kHz, V <sub>R</sub> or V <sub>L</sub> = 0.707V <sub>RMS</sub> (2V <sub>P-P</sub> ), (See Figure 6)	25	-	-110	-	dB
Total Harmonic Distortion	f = 20Hz to 20kHz, V <sub>DD</sub> = 3.0V, I <sub>N</sub> = CTRL = 3.0V, V <sub>L</sub> or V <sub>R</sub> = 0.707V <sub>RMS</sub> (2V <sub>P-P</sub> ), R <sub>L</sub> = 32Ω	25	-	0.06	-	%
USB Switch -3dB Bandwidth	Signal = 0dBm, 0.2V <sub>DC</sub> offset, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 5pF	25	-	630	-	MHz
D+/D- OFF Capacitance, C <sub>D+(OFF)</sub> , C <sub>D-(OFF)</sub>	f = 1MHz, V <sub>DD</sub> = 3.3V, I <sub>N</sub> = CTRL = 3.3V, V <sub>D-</sub> or V <sub>D+</sub> = V <sub>COMx</sub> = 0V, (See Figure 5)	25	-	6	-	pF
L/R OFF Capacitance, C <sub>LOFF</sub> , C <sub>ROFF</sub>	f = 1MHz, V <sub>DD</sub> = 3.3V, I <sub>N</sub> = 0V, CTRL = 3.3V, V <sub>L</sub> or V <sub>R</sub> = V <sub>COMx</sub> = 0V, (See Figure 5)	25	-	9	-	pF
COM ON Capacitance, C <sub>COM-(ON)</sub> , C <sub>COM+(ON)</sub>	f = 1MHz, V <sub>DD</sub> = 3.3V, I <sub>N</sub> = 0V, CTRL = 3.3V, V <sub>D-</sub> or V <sub>D+</sub> = V <sub>COMx</sub> = 0V, (See Figure 5)	25	-	10	-	pF
POWER SUPPLY CHARACTERISTICS						
Power Supply Range, V <sub>DD</sub>		Full	2.5	-	5.5	V
Positive Supply Current, I <sub>DD</sub>	V <sub>DD</sub> = 3.6V, I <sub>N</sub> = 0V or 3.6V, CTRL = 3.6V	25	-	6	8	μA
		Full	-	-	10	μA
Positive Supply Current, I <sub>DD</sub>	V <sub>DD</sub> = 4.2V, I <sub>N</sub> = 0V or 4.2V, CTRL = 4.2V	25	-	6	-	μA
Positive Supply Current, I <sub>DD</sub>	V <sub>DD</sub> = 5.0V, I <sub>N</sub> = 0V or 5.0V, CTRL = 5.0V	25	-	8	-	μA
Positive Supply Current, I <sub>DD</sub> (Low Power State)	V <sub>DD</sub> = 3.6V, I <sub>N</sub> = 3.6V, CTRL = 0V or float	25	-	1	7	nA
		Full	-	-	140	nA

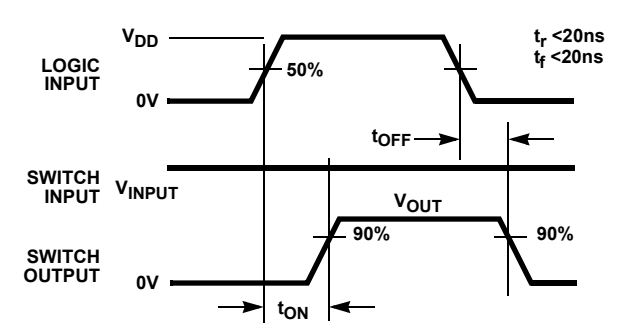
**Electrical Specifications - 2.7V to 3.6V Supply** Test Conditions:  $V_{DD} = +3.3V$ ,  $GND = 0V$ ,  $V_{INH} = 1.4V$ ,  $V_{INL} = 0.5V$ ,  $V_{CTRLH} = 1.4V$ ,  $V_{CTRLH} = 0.5V$ , (Note 4), unless otherwise specified. **(Continued)**

PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN (Notes 5, 8)	TYP	MAX (Notes 5, 8)	UNITS
<b>DIGITAL INPUT CHARACTERISTICS</b>						
Voltage Low, $V_{INL}$ , $V_{CTRLH}$	$V_{DD} = 2.7V$ to $3.6V$	Full	-	-	0.5	V
Voltage High, $V_{INH}$ , $V_{CTRLH}$	$V_{DD} = 2.7V$ to $3.6V$	Full	1.4	-	-	V
Input Current, $I_{INL}$ , $I_{INH}$	$V_{DD} = 3.6V$ , $IN = 0V$ or $3.6V$ , $CTRL = 0V$	25	-10	2.5	10	nA
		Full	-50	-	50	nA
Input Current, $I_{CTRLH}$	$V_{DD} = 3.6V$ , $IN = 0V$ , $CTRL = 0V$	25	-15	10	15	nA
		Full	-50	-	50	nA
Input Current, $I_{CTRLH}$	$V_{DD} = 3.6V$ , $IN = 0V$ , $CTRL = 3.6V$	25	-1.1	1.0	1.1	μA
		Full	-2	-	2	μA
CTRL Pull-Down Resistor, $R_{CTRL}$	$V_{DD} = 3.6V$ , $IN = 0V$ , $CTRL = 3.6V$	25	-	4	-	MΩ

NOTES:

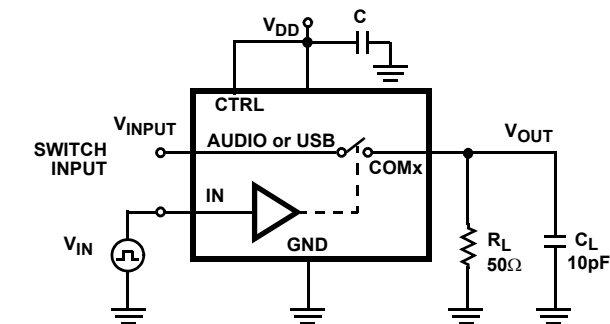
- 4.  $V_{LOGIC}$  = Input voltage to perform proper function.
- 5. The algebraic convention, whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- 6. Flatness is defined as the difference between maximum and minimum value of on-resistance over the specified analog signal range.
- 7.  $R_{ON}$  matching between channels is calculated by subtracting the channel with the highest max  $R_{ON}$  value from the channel with lowest max  $R_{ON}$  value, between L and R or between D+ and D-.
- 8. Parts are 100% tested at +25°C. Over temperature limits established by characterization and are not production tested.

**Test Circuits and Waveforms**



Logic input waveform is inverted for switches that have the opposite logic sense.

FIGURE 1A. MEASUREMENT POINTS



Repeat test for all switches.  $C_L$  includes fixture and stray capacitance.

$$V_{OUT} = V_{(INPUT)} \frac{R_L}{R_L + R_{(ON)}}$$

FIGURE 1B. TEST CIRCUIT

FIGURE 1. SWITCHING TIMES

## Test Circuits and Waveforms (Continued)

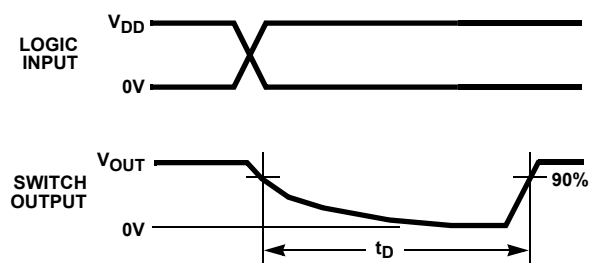
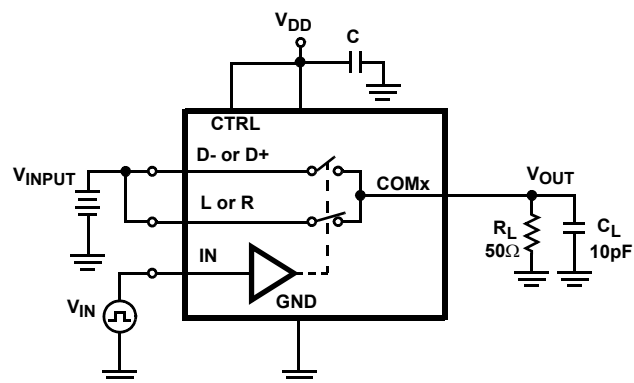


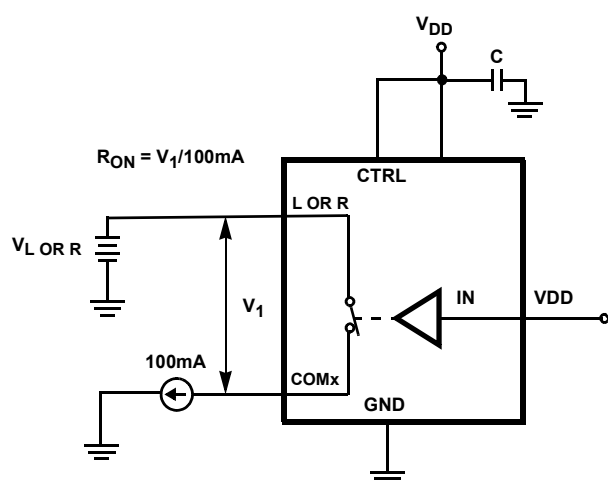
FIGURE 2A. MEASUREMENT POINTS

FIGURE 2. BREAK-BEFORE-MAKE TIME

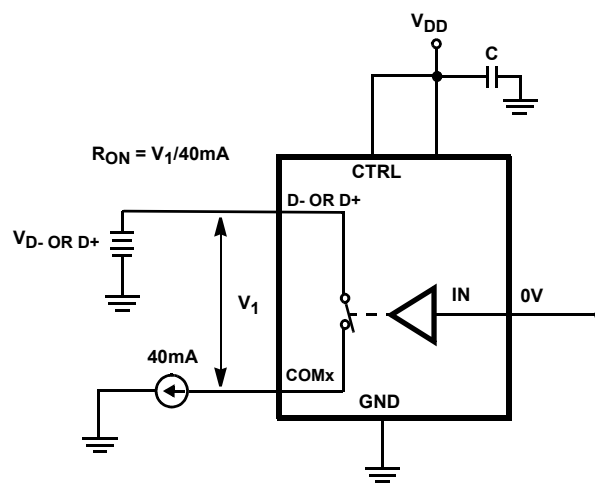


Repeat test for all switches.  $C_L$  includes fixture and stray capacitance.

FIGURE 2B. TEST CIRCUIT



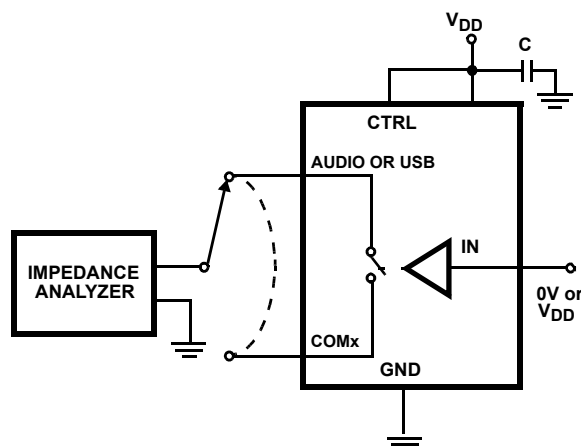
Repeat test for all switches.

FIGURE 3. AUDIO  $R_{ON}$  TEST CIRCUIT

Repeat test for all switches.

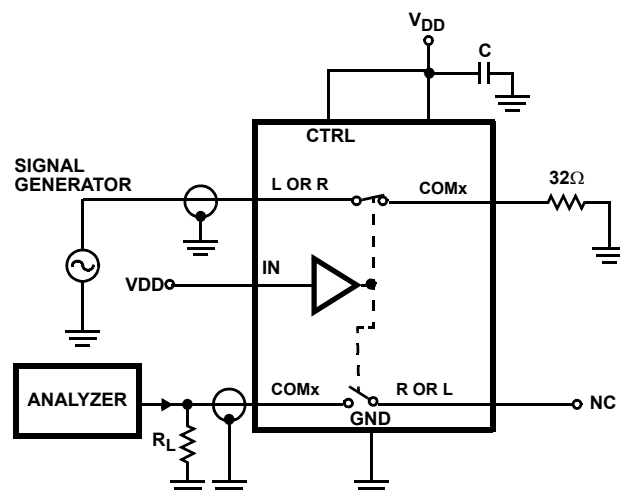
FIGURE 4. USB  $R_{ON}$  TEST CIRCUIT

## Test Circuits and Waveforms (Continued)



Repeat test for all switches.

FIGURE 5. CAPACITANCE TEST CIRCUIT



Signal direction through switch is reversed, worst case values are recorded. Repeat test for all switches.

FIGURE 6. AUDIO CROSSTALK TEST CIRCUIT

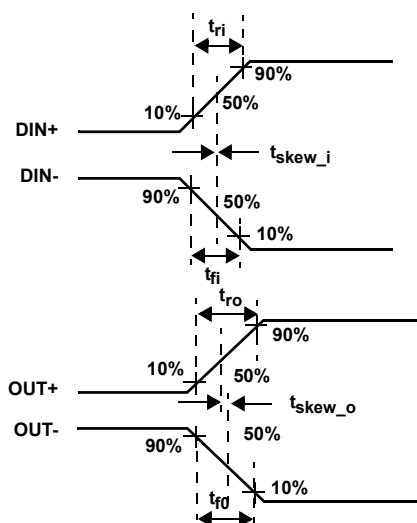
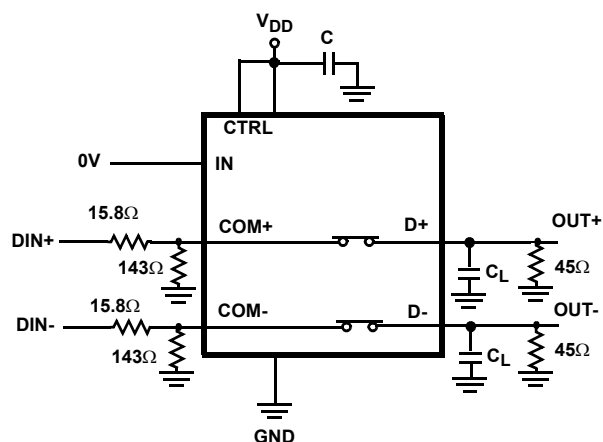


FIGURE 7A. MEASUREMENT POINTS



$|t_{ro} - t_{ri}|$  Delay Due to Switch for Rising Input and Rising Output Signals.  
 $|t_{fo} - t_{fi}|$  Delay Due to Switch for Falling Input and Falling Output Signals.  
 $|t_{skew\_0}|$  Change in Skew through the Switch for Output Signals.  
 $|t_{skew\_i}|$  Change in Skew through the Switch for Input Signals.

FIGURE 7B. TEST CIRCUIT

FIGURE 7. SKEW TEST



The two USB switches (D+, D-) are bidirectional switches that can pass rail-to-rail signals. When powered with a 3.6V supply these switches have a nominal  $r_{(ON)}$  of  $4.6\Omega$  over the



signal range of 0V to 400mV with a  $r_{(ON)}$  flatness of 0.4 $\Omega$ . The  $r_{(ON)}$  matching between the D+ and D- switches over this signal range is only 0.06 $\Omega$  ensuring minimal impact by the switches to USB high speed signal transitions. As the signal level increases the  $r_{(ON)}$  resistance increases. At signal level of 3.3V the switch resistance is nominally 23 $\Omega$ .

The USB switches were specifically designed to pass USB 2.0 high-speed (480Mbps) differential signals typically in the range of 0V to 400mV. They have low capacitance and high bandwidth to pass the USB high-speed signals with minimum edge and phase distortion to meet USB 2.0 high speed signal quality specifications. See the high-speed eye diagram in Figure 15.

The USB switches can also pass USB full-speed signals (12Mbps) with minimal distortion and meet all the USB requirements for USB 2.0 full-speed signaling. See the full-speed eye diagrams in Figures 12, 13 and 14.

The maximum signal range for the USB switches is from -1.5V to  $V_{DD}$ . The signal voltage at D- and D+ should not be allowed to exceed the  $V_{DD}$  voltage rail or go below ground by more than -1.5V.

The USB switches are active (turned ON) whenever the IN voltage is  $\leq 0.5V$ .

Note: Whenever the USB switches are ON the audio drivers of the CODEC need to be at AC or DC ground or floating to keep from interfering with the data transmission.

### ISL54212 Operation

The sections that follow will discuss using the ISL54212 in the typical application shown in the block diagram on page 8.

#### VDD SUPPLY

The DC power supply connected at VDD (pin 1) provides the required bias voltage for proper switch operation. The part can operate with a supply voltage in the range of 2.5V to 5.5V.

In a typical USB/Audio application for portable battery powered devices the  $V_{DD}$  voltage will come from a battery or an LDO and be in the range of 2.7V to 3.6V. For best possible USB full-speed operation (12Mbps) it is recommended that the  $V_{DD}$  voltage be  $\geq 2.5V$  in order to get a USB data signal level above 2.5V.

#### LOGIC CONTROL

The state of the ISL54212 device is determined by the voltage at the IN pin (pin 2) and the CTRL pin (pin 10). Refer to truth-table on page 2 of the data sheet. These logic pins are 1.8V logic compatible when  $V_{DD}$  is in the range of 2.7V to 3.6V and can be controlled by a standard  $\mu$ processor.

The CTRL pin is internally pulled low through a 4M $\Omega$  resistor to ground and can be tri-stated by the  $\mu$ processor. The CTRL control pin is only active when IN is logic "1".

The IN pin does not have an internal pull-down resistor and must not be allowed to float. It must be driven High or Low.

#### Logic control voltage levels:

IN = Logic "0" (Low) when  $IN \leq 0.5V$

IN = Logic "1" (High) when  $IN \geq 1.4V$

CTRL = Logic "0" (Low) when  $\leq 0.5V$  or floating

CTRL = Logic "1" (High) when  $\geq 1.4V$

#### Audio Mode

If the IN pin = Logic "1" and CTRL pin = Logic "1," the part will be in the Audio mode. In Audio mode the L (left) and R (right) 3 $\Omega$  audio switches are ON and the D- and D+ 5 $\Omega$  USB switches are OFF.

When nothing is plugged into the common connector or a headphone is plugged into the common connector, the  $\mu$ processor will sense that there is no voltage at the VBUS pin of the connector and will drive and hold the IN control pin of the ISL54212 high. As long as the CTRL = Logic "1," the ISL54212 part will be in the audio mode and the audio drivers of the media player can drive the headphones and play music.

#### USB Mode

If the IN pin = Logic "0" and CTRL pin = Logic "0" or Logic "1" the part will go into USB mode. In USB mode, the D- and D+ 5 $\Omega$  switches are ON and the L and R 3 $\Omega$  audio switches are OFF.

When a USB cable from a computer or USB hub is connected at the common connector, the  $\mu$ processor will sense the presence of the 5V  $V_{BUS}$  and drive the IN pin voltage low. The ISL54212 part will go into the USB mode. In USB mode, the computer or USB hub transceiver and the MP3 player or cell phone USB transceiver are connected and digital data will be able to be transmitted back and forth.

When the USB cable is disconnected, the  $\mu$ processor will sense that the 5V  $V_{BUS}$  voltage is no longer connected and will drive the IN pin high and put the part back into the Audio or Low Power mode.

#### Low Power Mode

If the IN pin = Logic "1" and CTRL pin = Logic "0," the part will be in the Low Power mode. In the Low Power mode, the audio switches and the USB switches are OFF. In this state, the device draws typically 1nA of current.

# Typical Performance Curves $T_A = +25^\circ\text{C}$ , Unless Otherwise Specified

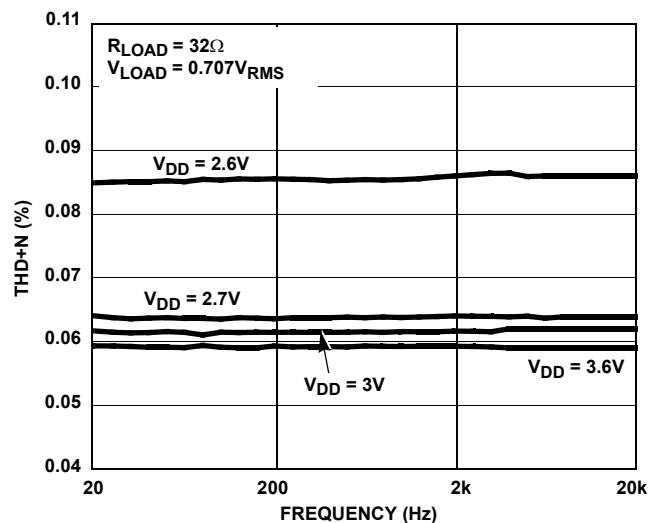


FIGURE 8. THD+N vs SUPPLY VOLTAGE vs FREQUENCY

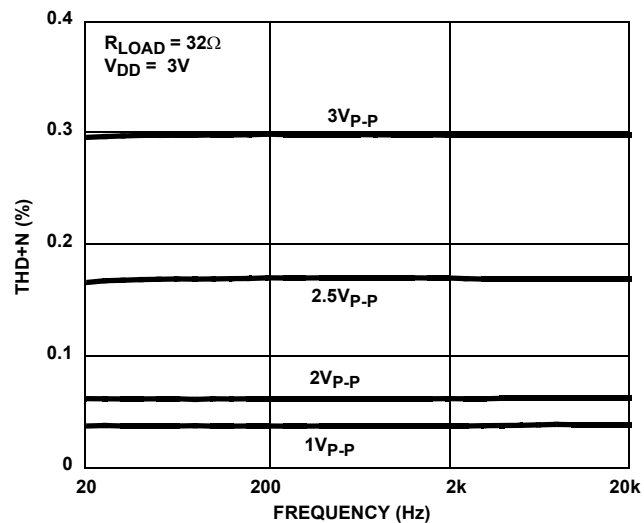


FIGURE 9. THD+N vs SIGNAL LEVELS vs FREQUENCY

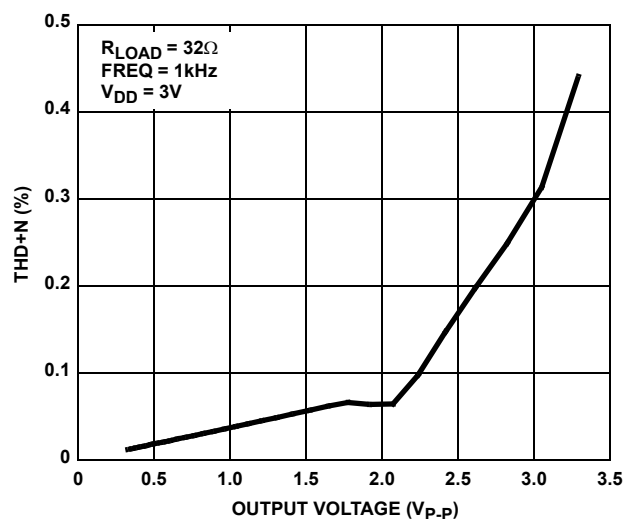


FIGURE 10. THD+N vs OUTPUT VOLTAGE

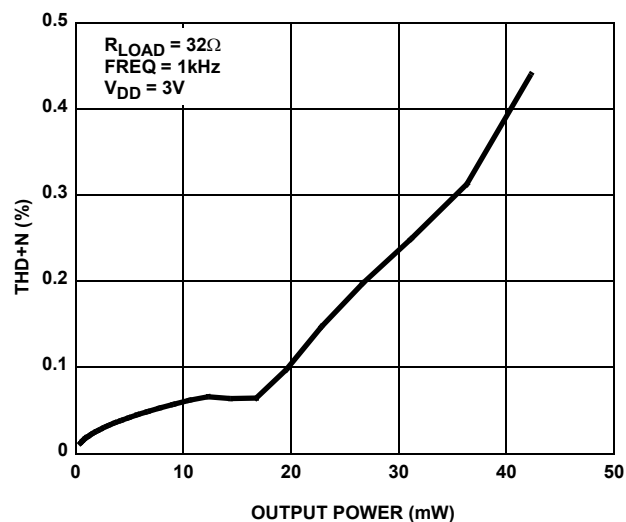
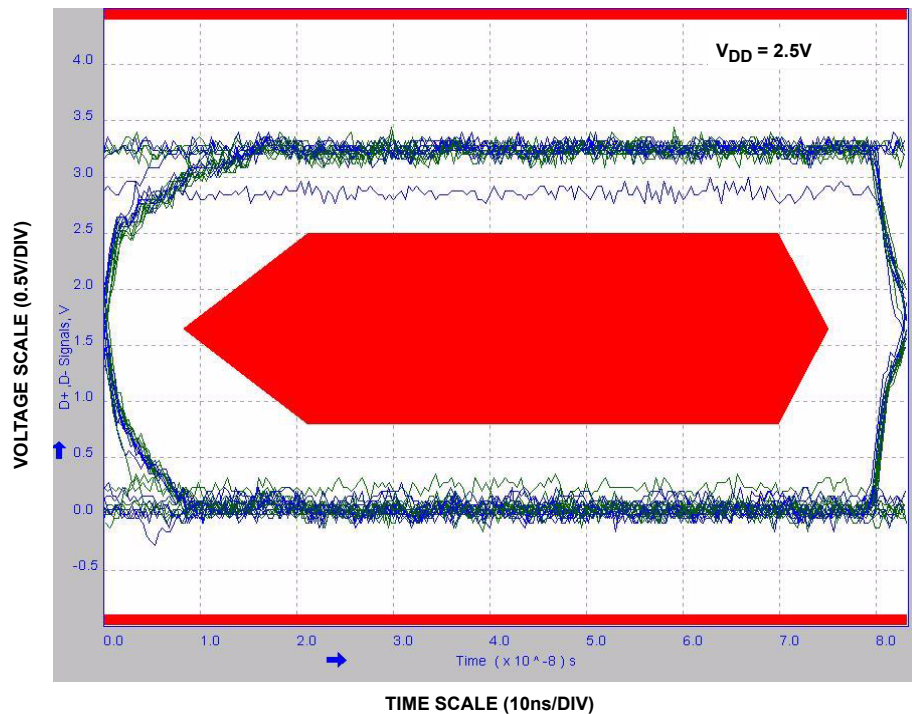
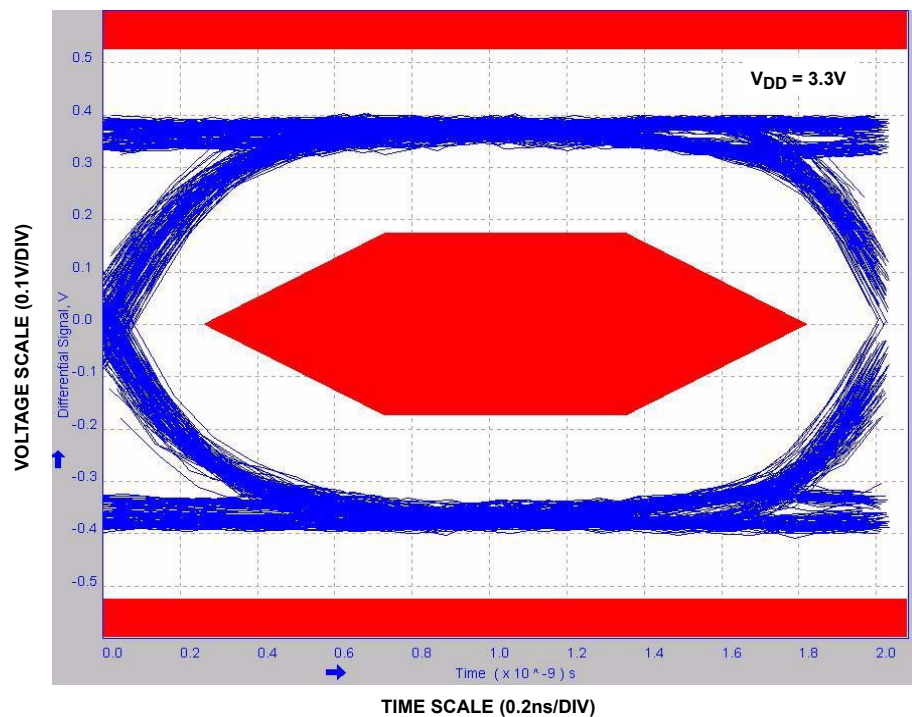


FIGURE 11. THD+N vs OUTPUT POWER



**Typical Performance Curves**  $T_A = +25^\circ\text{C}$ , Unless Otherwise Specified (Continued)**FIGURE 14. EYE PATTERN: 12Mbps WITH SWITCHES IN THE SIGNAL PATH****FIGURE 15. EYE PATTERN: 480Mbps USB SIGNAL WITH SWITCHES IN THE SIGNAL PATH**

## Typical Performance Curves $T_A = +25^\circ\text{C}$ , Unless Otherwise Specified (Continued)

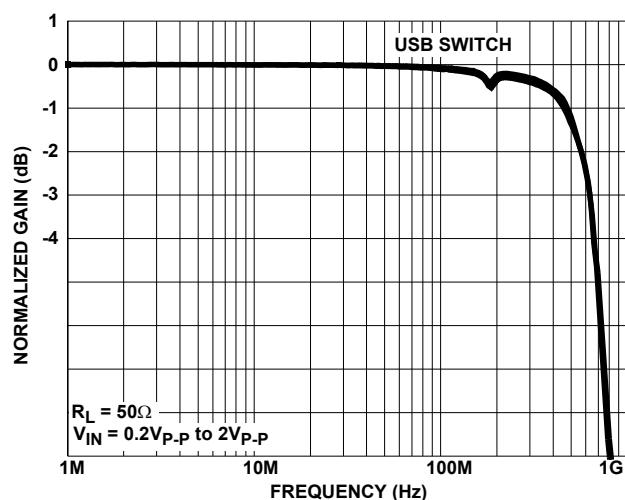


FIGURE 16. FREQUENCY RESPONSE

### Die Characteristics

#### SUBSTRATE POTENTIAL (POWERED UP):

GND (TDFN Paddle Connection: Tie to GND or Float)

#### TRANSISTOR COUNT:

98

#### PROCESS:

Submicron CMOS

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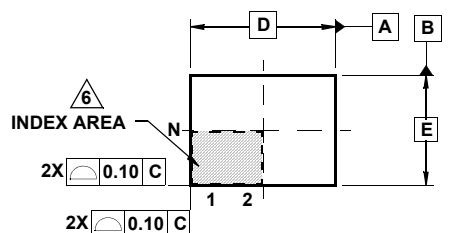
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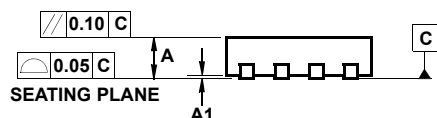
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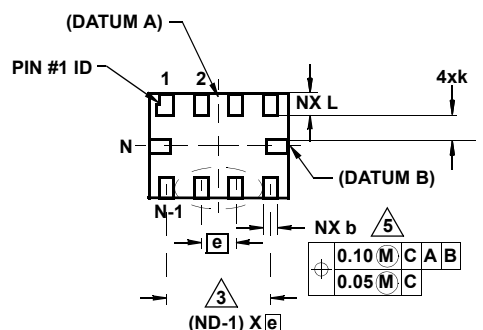
# Ultra Thin Quad Flat No-Lead Plastic Package (UTQFN)



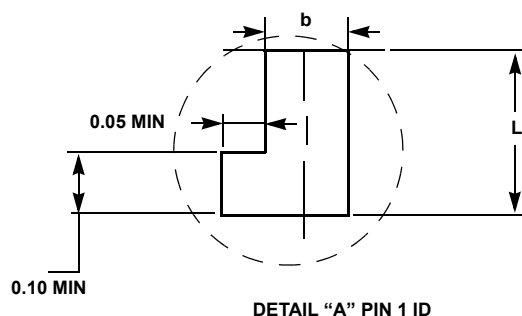
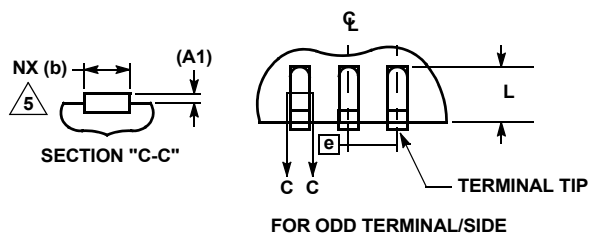
TOP VIEW



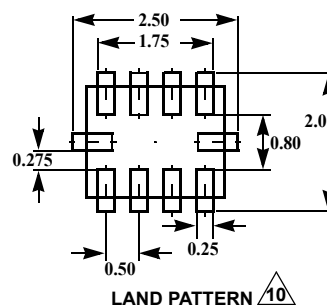
SIDE VIEW



BOTTOM VIEW



DETAIL "A" PIN 1 ID

LAND PATTERN  $\triangle 10$ 

## L10.2.1x1.6A

### 10 LEAD ULTRA THIN QUAD FLAT NO-LEAD PLASTIC PACKAGE

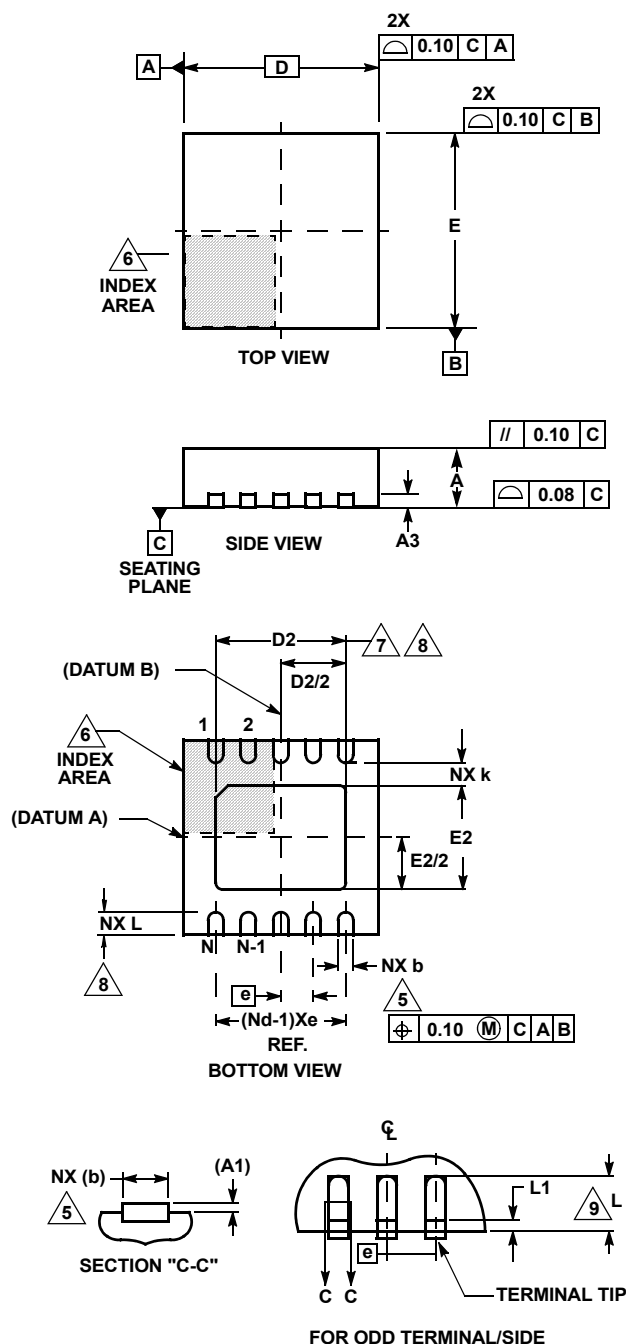
SYMBOL	MILLIMETERS			NOTES
	MIN	NOMINAL	MAX	
A	0.45	0.50	0.55	-
A1	-	-	0.05	-
A3	0.127 REF			-
b	0.15	0.20	0.25	5
D	2.05	2.10	2.15	-
E	1.55	1.60	1.65	-
e	0.50 BSC			-
k	0.20	-	-	-
L	0.35	0.40	0.45	-
N	10			2
Nd	4			3
Ne	1			3
$\theta$	0	-	12	4

Rev. 3 6/06

#### NOTES:

1. Dimensioning and tolerancing conform to ASME Y14.5-1994.
2. N is the number of terminals.
3. Nd and Ne refer to the number of terminals on D and E side, respectively.
4. All dimensions are in millimeters. Angles are in degrees.
5. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
7. Maximum package warpage is 0.05mm.
8. Maximum allowable burrs is 0.076mm in all directions.
9. Same as JEDEC MO-255UABD except:  
No lead-pull-back, "A" MIN dimension = 0.45 not 0.50mm  
"L" MAX dimension = 0.45 not 0.42mm.
10. For additional information, to assist with the PCB Land Pattern Design effort, see Intersil Technical Brief TB389.

## Thin Dual Flat No-Lead Plastic Package (TDFN)



### L10.3x3A

#### 10 LEAD THIN DUAL FLAT NO-LEAD PLASTIC PACKAGE

SYMBOL	MILLIMETERS			NOTES
	MIN	NOMINAL	MAX	
A	0.70	0.75	0.80	-
A1	-	-	0.05	-
A3	0.20 REF			-
b	0.20	0.25	0.30	5, 8
D	2.95	3.0	3.05	-
D2	2.25	2.30	2.35	7, 8
E	2.95	3.0	3.05	-
E2	1.45	1.50	1.55	7, 8
e	0.50 BSC			-
k	0.25	-	-	-
L	0.25	0.30	0.35	8
N	10			2
Nd	5			3

Rev. 3 3/06

#### NOTES:

1. Dimensioning and tolerancing conform to ASME Y14.5-1994.
2. N is the number of terminals.
3. Nd refers to the number of terminals on D.
4. All dimensions are in millimeters. Angles are in degrees.
5. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
7. Dimensions D2 and E2 are for the exposed pads which provide improved electrical and thermal performance.
8. Nominal dimensions are provided to assist with PCB Land Pattern Design efforts, see Intersil Technical Brief TB389.
9. Compliant to JEDEC MO-229-WEED-3 except for D2 dimensions.